

CMOS Dual 64-Stage Static Shift Register

CD4517B Types

High-Voltage Types (20-Volt Rating)

■ CD4517B dual 64-stage static shift register consists of two independent registers each having a clock, data, and write enable input and outputs accessible at taps following the 16th, 32nd, 48th, and 64th stages. These taps also serve as input points allowing data to be inputted at the 17th, 33rd, and 49th stages when the write enable input is a logic 1 and the clock goes through a low-to-high transition. The truth table indicates how the clock and write enable inputs control the operation of the CD4517B. Inputs at the intermediate taps allow entry of 64 bits into the register with 16 clock pulses. The 3-state outputs permit connection of this device to an external bus.

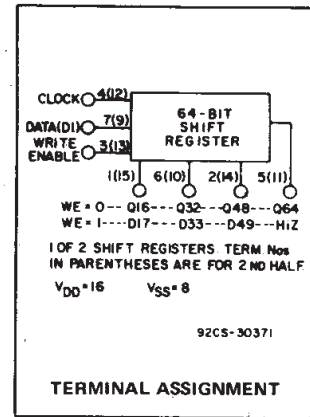
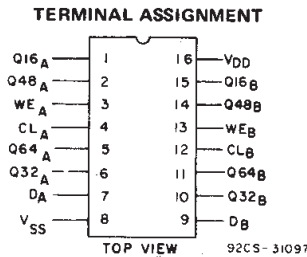
The CD4517B is supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

Features:

- Low quiescent current – 10 nA/pkg (typ.) at $V_{DD} = 5V$
- Clock frequency 12 MHz (typ.) at $V_{DD} = 10V$
- Schmitt trigger clock inputs allow operation with very slow clock rise and fall times
- Capable of driving two low-power TTL loads, one low-power Schottky TTL load, or two HTL loads
- Three-state outputs
- 100% tested for quiescent current at 20 V
- Standardized, symmetrical output characteristics
- 5-V, 10-V and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Time-delay circuits
- Scratch-pad memories
- General-purpose serial shift-register applications



MAXIMUM RATINGS, Absolute-Maximum Values:

| | |
|--|--|
| DC SUPPLY-VOLTAGE RANGE, (V_{DD}) | -0.5V to +20V |
| Voltages referenced to V_{SS} Terminal) | |
| INPUT VOLTAGE RANGE, ALL INPUTS | -0.5V to $V_{DD} + 0.5V$ |
| DC INPUT CURRENT, ANY ONE INPUT | $\pm 10\mu A$ |
| POWER DISSIPATION PER PACKAGE (P_D): | |
| For $T_A = -55^\circ C$ to $+100^\circ C$ | 500mW |
| For $T_A = +100^\circ C$ to $+125^\circ C$ | Derate Linearly at 12mW/ $^\circ C$ to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR | |
| FOR $T_A =$ FULL PACKAGE-TEMPERATURE RANGE (All Package Types) | 100mW |
| OPERATING-TEMPERATURE RANGE (T_A) | $-55^\circ C$ to $+125^\circ C$ |
| STORAGE TEMPERATURE RANGE (T_{stg}) | $-65^\circ C$ to $+150^\circ C$ |
| LEAD TEMPERATURE (DURING SOLDERING): | |
| At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79mm) from case for 10s max | $+265^\circ C$ |

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC | LIMITS | | UNITS |
|---|--------|------|-------|
| | MIN. | MAX. | |
| Supply-Voltage Range (For $T_A =$ Full Package Temperature Range) | 3 | 18 | V |

TRUTH TABLE

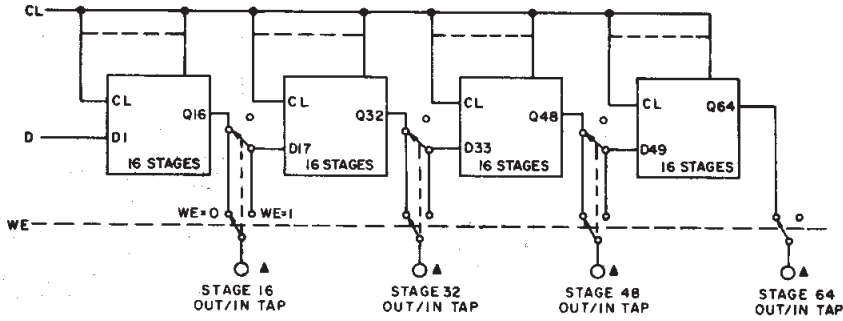
| Clock | Write Enable | Data | Stage 16 Tap | Stage 32 Tap | Stage 48 Tap | Stage 64 Tap |
|-------|--------------|-------|--------------|--------------|--------------|--------------|
| 0 | 0 | X | Q16 | Q32 | Q48 | Q64 |
| 0 | 1 | X | Z | Z | Z | Z |
| 1 | 0 | X | Q16 | Q32 | Q48 | Q64 |
| 1 | 1 | X | Z | Z | Z | Z |
| ~ | 0 | DI In | Q16 | Q32 | Q48 | Q64 |
| ~ | 1 | DI In | D17 In | D33 In | D49 In | Z |
| ~ | 0 | X | Q16 | Q32 | Q48 | Q64 |
| ~ | 1 | X | Z | Z | Z | Z |

X = Don't Care

Z = High Impedance

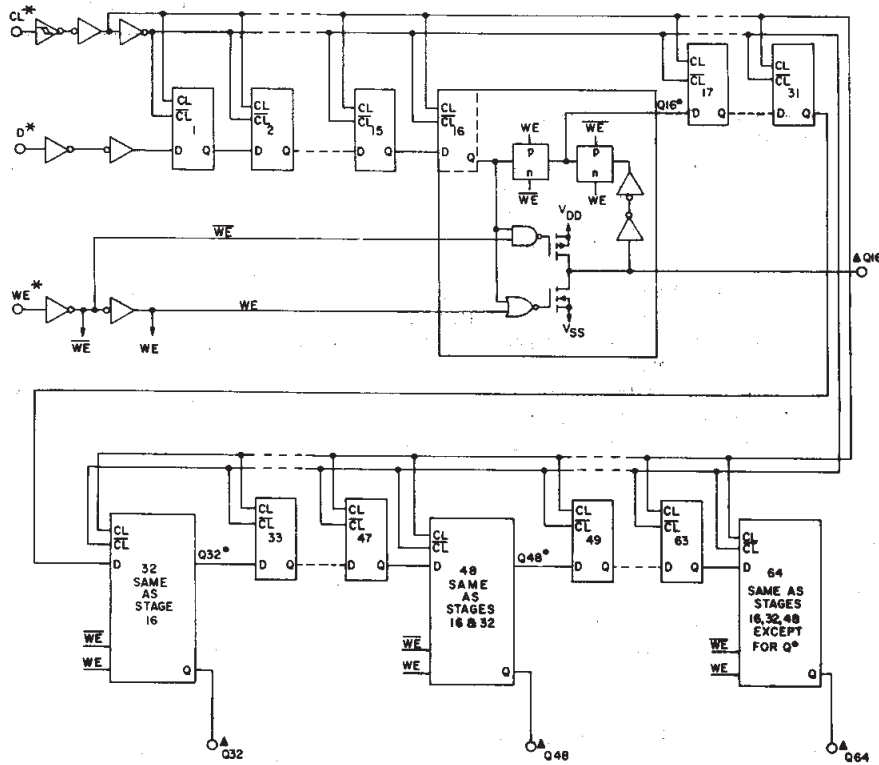
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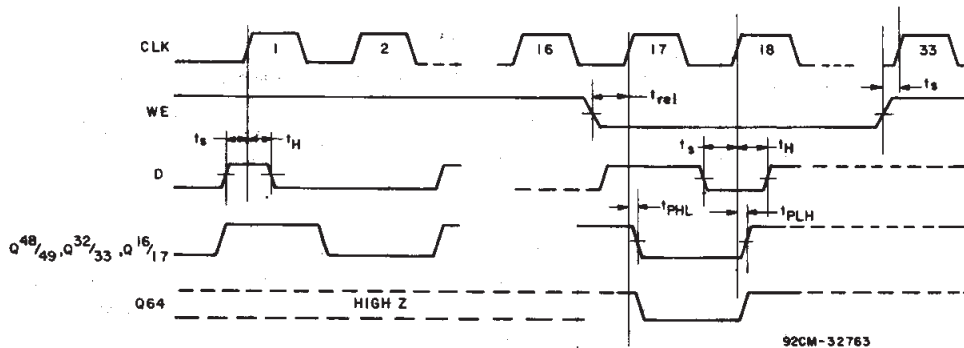
92CM-31098R1

Fig. 1—CD4517B functional block diagram (one half).



92CL-32765

Fig. 2—CD4517B logic block diagram (one half).



92CM-32763

Fig. 3—Dynamic test waveforms.

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STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC | CONDITIONS | | | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | UNITS |
|--|--------------------|---------------------|---------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
| | V _O (V) | V _{IN} (V) | V _{DD} (V) | -55 | -40 | +85 | +125 | +25 | | | |
| | | | | | | | | Min. | Typ. | Max. | |
| Quiescent Device Current, I _{DD} Max. | - | 0,5 | 5 | 5 | 5 | 150 | 150 | - | 0,04 | 5 | μA |
| | - | 0,10 | 10 | 10 | 10 | 300 | 300 | - | 0,04 | 10 | |
| | - | 0,15 | 15 | 20 | 20 | 600 | 600 | - | 0,04 | 20 | |
| | - | 0,20 | 20 | 100 | 100 | 3000 | 3000 | - | 0,08 | 100 | |
| Output Low (Sink) Current I _{OL} Min. | 0,4 | 0,5 | 5 | 0,64 | 0,61 | 0,42 | 0,36 | 0,51 | 1 | - | mA |
| | 0,5 | 0,10 | 10 | 1,6 | 1,5 | 1,1 | 0,9 | 1,3 | 2,6 | - | |
| | 1,5 | 0,15 | 15 | 4,2 | 4 | 2,8 | 2,4 | 3,4 | 6,8 | - | |
| Output High (Source) Current, I _{OH} Min. | 4,6 | 0,5 | 5 | -0,64 | -0,61 | -0,42 | -0,36 | -0,51 | -1 | - | mA |
| | 2,5 | 0,5 | 5 | -2 | -1,8 | -1,3 | -1,15 | -1,6 | -3,2 | - | |
| | 9,5 | 0,10 | 10 | -1,6 | -1,5 | -1,1 | -0,9 | -1,3 | -2,6 | - | |
| | 13,5 | 0,15 | 15 | -4,2 | -4 | -2,8 | -2,4 | -3,4 | -6,8 | - | |
| Output Voltage: Low-Level, V _{OL} Max. | - | 0,5 | 5 | 0,05 | | | - | 0 | 0,05 | - | V |
| | - | 0,10 | 10 | 0,05 | | | - | 0 | 0,05 | - | |
| | - | 0,15 | 15 | 0,05 | | | - | 0 | 0,05 | - | |
| Output Voltage: High-Level, V _{OH} Min. | - | 0,5 | 5 | 4,95 | | | 4,95 | 5 | - | - | V |
| | - | 0,10 | 10 | 9,95 | | | 9,95 | 10 | - | - | |
| | - | 0,15 | 15 | 14,95 | | | 14,95 | 15 | - | - | |
| Input Low Voltage V _{IL} Max. | 0,5, 4,5 | - | 5 | 1,5 | | | - | - | 1,5 | - | V |
| | 1,9 | - | 10 | 3 | | | - | - | 3 | - | |
| | 1,5, 13,5 | - | 15 | 4 | | | - | - | 4 | - | |
| Input High Voltage V _{IH} Min. | 0,5, 4,5 | - | 5 | 3,5 | | | 3,5 | - | - | - | V |
| | 1,9 | - | 10 | 7 | | | 7 | - | - | - | |
| | 1,5, 13,5 | - | 15 | 11 | | | 11 | - | - | - | |
| Input Current I _{IN} Max. | - | 0,18 | 18 | ±0,1 | ±0,1 | ±1 | ±1 | - | ±10 ⁻⁵ | ±0,1 | μA |
| 3-State Output Leakage Current I _{OUT} Max. | 0,18 | 0,18 | 18 | ±0,4 | ±0,4 | ±12 | ±12 | - | ±10 ⁻⁴ | ±0,4 | μA |

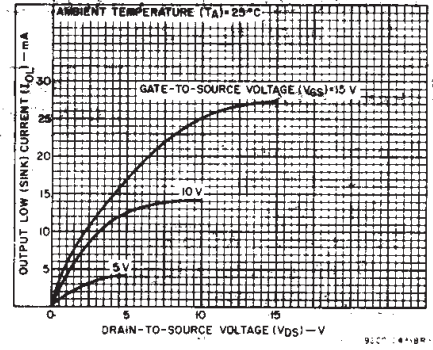


Fig. 4—Typical n-channel output low (sink) current characteristics.

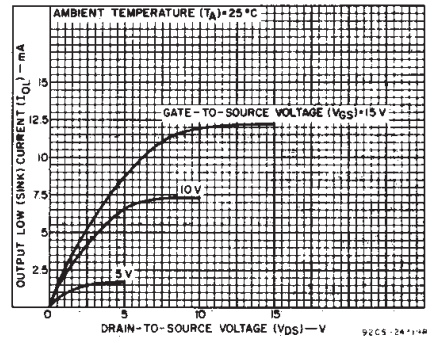


Fig. 5—Minimum n-channel output low (sink) current characteristics.

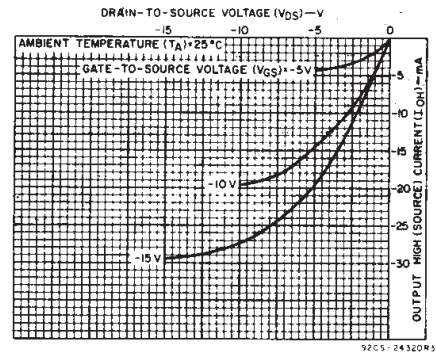


Fig. 6—Typical p-channel output high (source) current characteristics.

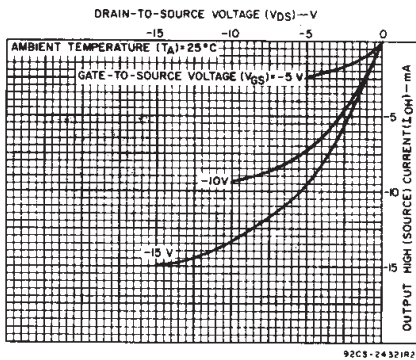


Fig. 7—Minimum p-channel output high (source) current characteristics.

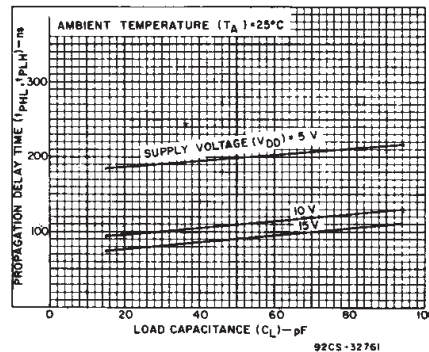


Fig. 8—Typical propagation delay time as a function of load capacitance.

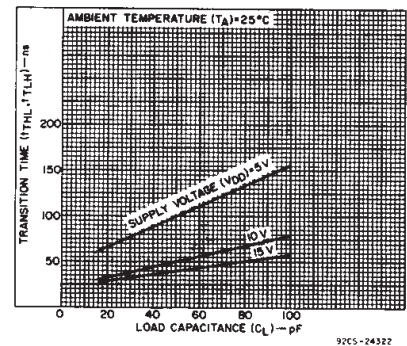


Fig. 9—Typical transition time as a function of load capacitance.

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DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$; Input $t_r, t_f = 20\text{ ns}$, $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

| CHARACTERISTIC | TEST CONDITIONS | V _{DD} (V) | LIMITS | | | UNITS |
|---|-----------------|---------------------|-----------|------|------|-------|
| | | | Min. | Typ. | Max. | |
| Propagation Delay Time: CL to Bit 16 Tap t _{PHL} , t _{PLH} | | 5 | — | 200 | 400 | ns |
| | | 10 | — | 110 | 220 | |
| | | 15 | — | 90 | 180 | |
| 3-State Output, WE to Bit 16 Tap t _{PZH} , t _{PLZ} ; t _{PZH} , t _{PZL} (See Note) | | 5 | — | 75 | 150 | ns |
| | | 10 | — | 40 | 80 | |
| | | 15 | — | 30 | 60 | |
| Output Transition Time t _{THL} , t _{TLH} | | 5 | — | 100 | 200 | ns |
| | | 10 | — | 50 | 100 | |
| | | 15 | — | 40 | 80 | |
| Write Enable-to-Clock Setup Time | | 5 | 0 | -50 | — | ns |
| | | 10 | 0 | -25 | — | |
| | | 15 | 0 | -15 | — | |
| Data-to-Clock Setup Time, t _s | | 5 | 20 | 0 | — | ns |
| | | 10 | 10 | 0 | — | |
| | | 15 | 10 | 0 | — | |
| Minimum Write Enable-to-Clock Release Time | | 5 | — | 50 | 100 | ns |
| | | 10 | — | 25 | 50 | |
| | | 15 | — | 20 | 40 | |
| Minimum Data-to-Clock Hold Time, t _H | | 5 | — | 100 | 200 | ns |
| | | 10 | — | 50 | 100 | |
| | | 15 | — | 25 | 50 | |
| Minimum Clock Pulse Width, t _W | | 5 | — | 90 | 180 | ns |
| | | 10 | — | 40 | 80 | |
| | | 15 | — | 25 | 50 | |
| Maximum Clock Input Frequency, f _{CL} | | 5 | 3 | 6 | — | MHz |
| | | 10 | 6 | 12 | — | |
| | | 15 | 8 | 15 | — | |
| Maximum Clock Input Rise or Fall Time, t _{rCL} , t _{fCL} | | 5 | UNLIMITED | | | μs |
| | | 10 | UNLIMITED | | | |
| | | 15 | UNLIMITED | | | |
| Input Capacitance C _{IN} | Any Input | | — | 5 | 7.5 | pF |

NOTE: Measured at the point of 10% change in output with an output load of 50 pF, R_L = 1 kΩ to V_{DD} for t_{PZL}, t_{PLZ} and R_L = 1 kΩ to V_{SS} for t_{PZH}, t_{PHZ}.

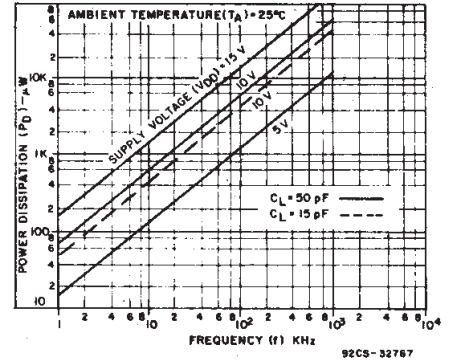


Fig. 10—Typical power dissipation as a function of frequency.

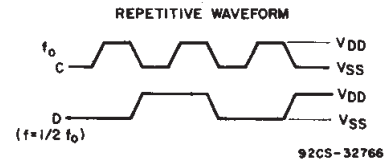
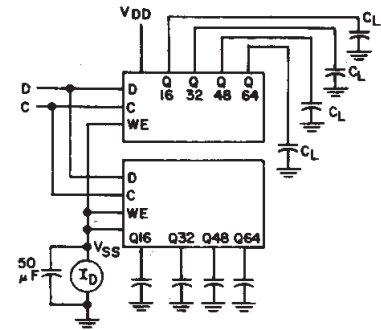


Fig. 11—Dynamic power dissipation test circuit and waveforms.

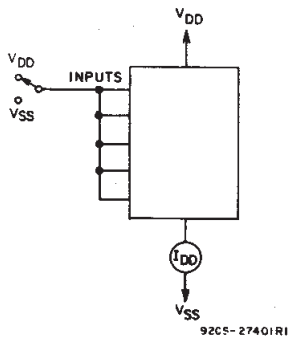


Fig. 12—Quiescent device current test circuit.

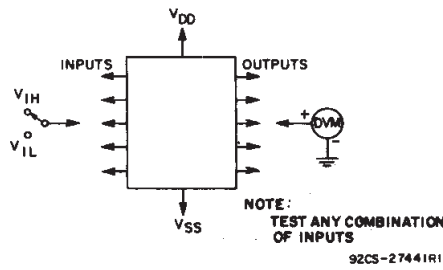


Fig. 13—Input voltage test circuit.

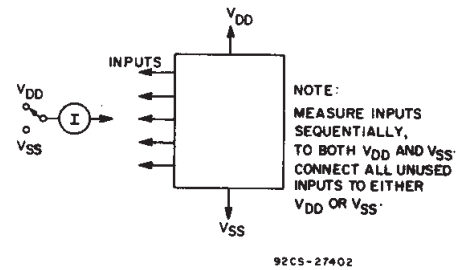
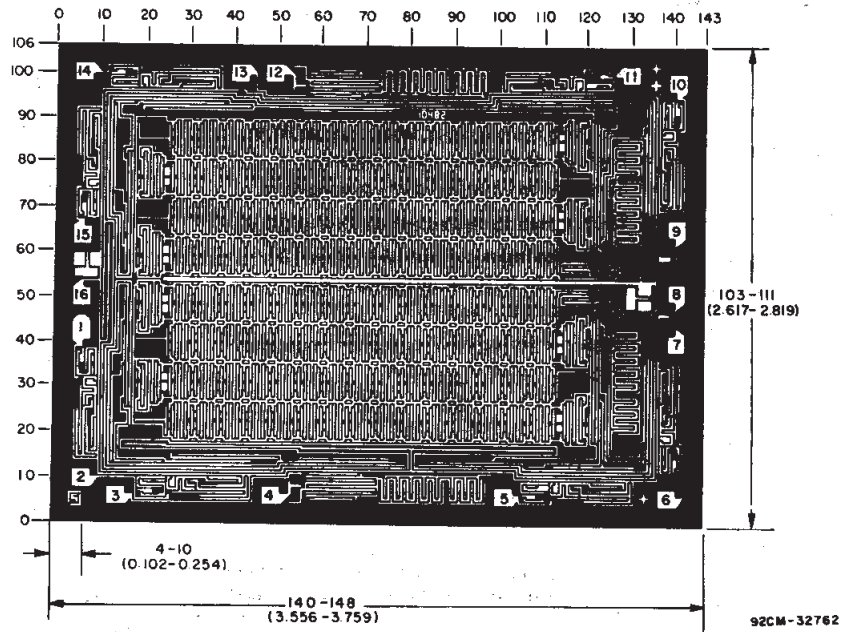


Fig. 14—Input current test circuit.

CD4517B Types



Dimensions and pad layout for CD4517B.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

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PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CD4517BE | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD4517BE |
| CD4517BE.A | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | -55 to 125 | CD4517BE |
| CD4517BF3A | NRND | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD4517BF3A |
| CD4517BF3A.A | NRND | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | CD4517BF3A |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF CD4517B, CD4517B-MIL :

- Catalog : [CD4517B](#)
- Military : [CD4517B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD4517BE | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| CD4517BE.A | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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